

BSW-115-24-S-M

BSW-115-24-S-M Information

Heisener.com	Part Number	BSW-115-24-S-M	
	Manufacturer	Samtec Inc.	
	Category	Connectors, Interconnects Rectangular Connectors - Headers, Receptacles, Female Sockets	- 国家税,国
	Description Package	BOTTOM MOUNT STRIPS	
For Reference Only	-	For the pricing/inventory/lead time, please contact	
		Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



BSW-115-24-S-M Specifications

Manufacturer Part NumberBSW-115-24-S-MManufacturerSamtec Inc.CategoryConnectors, InterconnectsPackage-SeriesBSWConnector TypeReceptacle, BreakawayContact TypeFemale SocketStyleBoard to BoardNumber of Positions15Number of Rows1Rows Spacing - MatingMounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldMounting TypeSolderInsulation ColorBlackInsulation ColorBlackInsulation Height0.350" (8.89mm)Contact Length - Post0.125" (3.18mm)		
CategoryConnectors, Interconnects Rectangular Connectors - Headers, Receptacles, Female SocketsPackage-SeriesBSWConnector TypeReceptacle, BreakawayContact TypeFemale SocketStyleBoard to BoardNumber of Positions15Number of Positions LoadedAllPitch - Mating0.100" (2.54mm)Number of Rows1Row Spacing - Mating-Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Manufacturer Part Number	BSW-115-24-S-M
Package-SeriesBSWConnector TypeReceptacle, BreakawayContact TypeFemale SocketStyleBoard to BoardNumber of Positions15Number of Positions LoadedAllPitch - Mating0.100" (2.54mm)Number of Rows1Row Spacing - Mating-Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypeQuin (0.76µm)Contact Finish Thickness - Mating30µin (0.76µm)Insulation Height0.350" (8.89mm)	Manufacturer	Samtec Inc.
Package-SeriesBSWConnector TypeReceptacle, BreakawayContact TypeFemale SocketStyleBoard to BoardNumber of Positions15Number of Positions LoadedAllPitch - Mating0.100" (2.54mm)Number of Rows1Row Spacing - Mating-Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypeQuin (0.76µm)Contact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Category	Connectors, Interconnects
SeriesBSWConnector TypeReceptacle, BreakawayContact TypeFemale SocketStyleBoard to BoardNumber of Positions15Number of Positions LoadedAllPitch - Mating0.100" (2.54mm)Number of Rows1Row Spacing - Mating-Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)		Rectangular Connectors - Headers, Receptacles, Female Sockets
Connector TypeReceptacle, BreakawayContact TypeFemale SocketStyleBoard to BoardNumber of Positions15Number of Positions LoadedAllPitch - Mating0.100" (2.54mm)Number of Rows1Row Spacing - Mating-Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypePush-PullContact Finish - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Package	-
Contact TypeFemale SocketStyleBoard to BoardNumber of Positions15Number of Positions LoadedAllPitch - Mating0.100" (2.54mm)Number of Rows1Row Spacing - Mating-Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Series	BSW
StyleBoard to BoardStyleBoard to BoardNumber of Positions15Number of Positions LoadedAllPitch - Mating0.100" (2.54mm)Number of Rows1Row Spacing - Mating-Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Connector Type	Receptacle, Breakaway
Number of Positions15Number of Positions LoadedAllPitch - Mating0.100" (2.54mm)Number of Rows1Row Spacing - Mating-Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Contact Type	Female Socket
Number of Positions LoadedAllPitch - Mating0.100" (2.54mm)Number of Rows1Row Spacing - Mating-Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Style	Board to Board
Pitch - Mating0.100" (2.54mm)Number of Rows1Row Spacing - Mating-Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Number of Positions	15
Number of Rows1Row Spacing - Mating-Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Number of Positions Loaded	All
Row Spacing - Mating-Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Pitch - Mating	0.100" (2.54mm)
Mounting TypeThrough Hole, Bottom MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Number of Rows	1
TerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating30μin (0.76μm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Row Spacing - Mating	-
Fastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Mounting Type	Through Hole, Bottom Mount
Contact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Termination	Solder
Contact Finish Thickness - Mating30μin (0.76μm)Insulation ColorBlackInsulation Height0.350" (8.89mm)	Fastening Type	Push-Pull
Insulation ColorBlackInsulation Height0.350" (8.89mm)	Contact Finish - Mating	Gold
Insulation Height 0.350" (8.89mm)	Contact Finish Thickness - Mating	30µin (0.76µm)
	Insulation Color	Black
Contact Length - Post 0.125" (3.18mm)	Insulation Height	0.350" (8.89mm)
	Contact Length - Post	0.125" (3.18mm)
Operating Temperature $-55^{\circ}C \sim 125^{\circ}C$	Operating Temperature	-55°C ~ 125°C
Material Flammability Rating UL94 V-0	Material Flammability Rating	UL94 V-0

Contact Finish - Post	Tin
Mated Stacking Heights	-
Ingress Protection	-
Features	-
	Report errors?

BSW-115-24-S-M Guarantees



Quality Guarantees

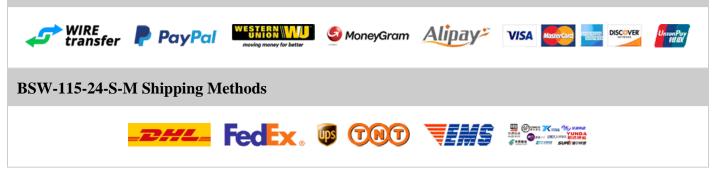
We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

BSW-115-24-S-M Payment Methods



If you have any question about BSW-115-24-S-M, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com